

SPECIFICATIONS					
CUSTOMER	· PTC				
SAMPLE CODE	SH240320T068-LAB08				
MASS PRODUCTION CODE	- PH240320T068-LAB08				
SAMPLE VERSION	. 01				
SPECIFICATIONS EDITION	003				
DRAWING NO. (Ver.)	JLMD-PH240320T068-LAB08_001				
PACKAGING NO. (Ver.)					

Customer Approved

Date:

	Approved	Checked	Designer		
	閆偉	劉進	陳璐		
	Preliminary specification Specification for sample	- .			
	Specification for sample	- .			
□ ■ eadqua	Specification for sample	e approval OWERTIP TECH. CORP.			



History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
01/18/2019	01	001	New Drawing	-	陳璐
03/05/2019	01	002	New Sample	-	陳璐
04/09/2019	01	003	Modify Initial code	16~18	陳璐
				Т	otal: 33 Page



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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): Sitronix : ST7789VI



1. SPECIFICATIONS

1.1 Features

Main LCD panel

Item	Standard Value
Display Type	240(R \ G \ B) * 320 Dots
LCD Type	Normally white, Transmissive type
Screen size(inch)	2.8 inch
Viewing Direction	12 O'clock
Color configuration	RGB-Strip
Interface	80-16bit parallel I/F II
Other(controller/driver IC)	Sitronix: ST7789VI
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	50.0(W) * 69.2 (L) * 4.25 (H)max	mm

LCD panel

Item	Standard Value		
Active Area	43.2 (W) * 57.6 (L)	mm	





1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
	VCC	-	-0.3	+4.6	V
System Power Supply Voltage	VGH ~ VGL	-	-0.3	+30	V
Input Voltage	VIN	-	-0.3	VCC+0.5	V
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C
Storage Humidity	H⊳	Ta \leq 40 °C	20	90	%RH

1.4 DC Electrical Characteristics

Module

GND = 0V, Ta = 25°C

Wodule				J = 0V, 1a -	25 0	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage1	VCC	-	2.4	2.8	3.6	V
Input High Voltage	Vih	-	0.7 VCC	-	VCC	V
Input Low Voltage	VIL	-	GND	-	0.3 VCC	V
Output High Voltage	Vон	IOH=-0.1mA	0.8*VCC	-	VCC	V
Output Low Voltage	Vol	IOL=0.1mA	GND	-	0.2*VCC	V
Supply Current	ICC	VCC = 2.8V	-	8	12	mA

Note1:Maximum current display



1.5 Optical Characteristics

TFT LCD Module

VCC = 2.8V, Ta=25°C

							,	10-25 0
Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response tin	ne	Tr+ Tf	_	-	30	45	ms	Note2
	Тор	θY+		-	60	-		
Viewing angle	Bottom	θY-	CR ≥ 10	-	60	-	Dog	Note4
	Left	θХ-	CR 2 10	-	60	-	Deg.	NOLE4
	Right	θX+		-	60	1		
Contrast rati	0	CR	-	500	600	-	-	Note3
	\//bito	Х		0.25	0.30	0.35		
	White	Y	IF=80 mA	0.26	0.31	0.36		
	Red	Х		0.57	0.62	0.67		
Color of CIE Coordinate		Y		0.31	0.36	0.41		
(With B/L)	Green	Х		0.28	0.33	0.38		
		Y		0.55	0.60	0.65		
	Blue	Х		0.10	0.15	0.20	_	Note1
	Diue	Y		0.03	0.08	0.13		
Average Brightr	ness							
Pattern=white di	Pattern=white display		IF=80 mA	200	250	-	cd/m ²	
(With B/L) *	1							
Uniformity (With B/L)*2	2	∆B	IF=80 mA	70	-	-	%	

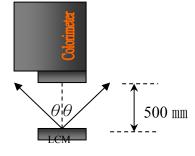
Note 1:

*1 : △B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

- a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
- b : Measurement Distance: 500 ± 50 mm \rightarrow (θ = 0°)
- c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
- d: The uncertainty of the C.I.E coordinate measurement ±0.01 , Average Brightness ± 4%





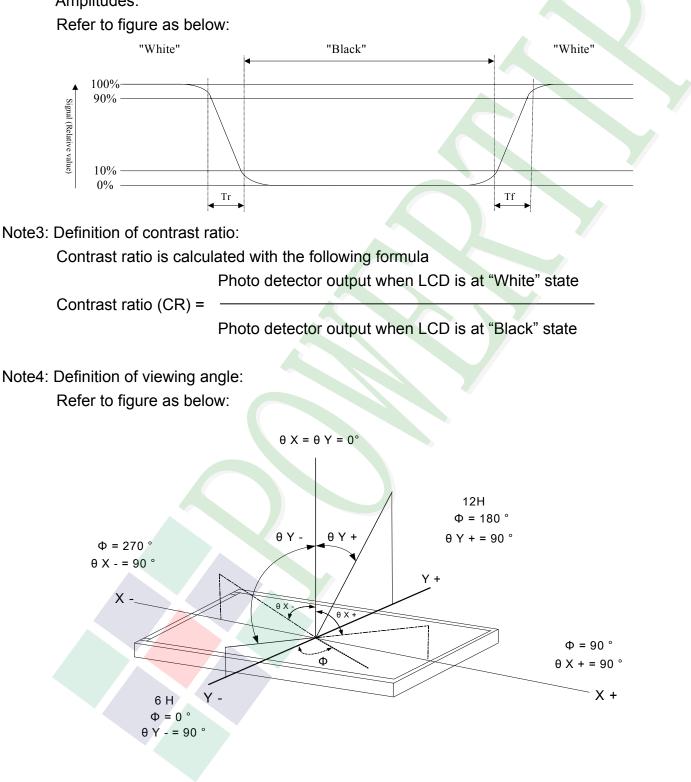
Colorimeter=BM-7 fast

To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.





1.6 Backlight Characteristics

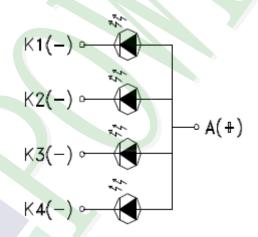
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25 ℃	-	30*4	mA
Reverse Voltage	VR	Ta =25 ℃	-	5	V
Power Dissipation	PD	Ta =25℃	-	90*4	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		3.0	-	3.6	V
Average Brightness (without LCD)	IV	IF= 80 mA	5000	5500		cd/m ²
CIE Color Coordinate	Х		0.26	0.28	0.33	
(Without LCD)	Y		0.26	0.28	0.33	-
Color			White			

Internal Circuit



Other Description

Item	Conditions	Description
Life Time	Ta =25℃ IF= 80 mA	20000 hrs



1.7 Touch Panel Characteristics

1.7.1 Optical Characteristics

Item	Specification		
1.Transparency	80% Min		

1.7.2 Mechanical Characteristic

Item	Specification			
1.Input Method	Finger or stylus pen			
2.Hardness of surface	3 H-pressure 500g of ,45deg.			
3.FPC peeling strength	50gf min(Peeling upward by 90°)			
4.Activation Force	50gf(Typical 20gf) less individual point with stylus pen(R0.8mm)			
	Activation force guarantee area:5.0mm inside of Active Area.			
5.Linearity Force	80gf less input with stylus pen(R0.8mm)			
	Linearity force guarantee area:3.0mm inside of Active Area.			

1.7.3 Electrical Characteristics

Item	Specification
1.Rated Voltage	DC 5V(DC 10V Max)
2.Resistance Between	Direction X (Glass side): 100Ω~ 600Ω
Terminals.	Direction Y (Film side): 250Ω~ 900Ω
3.Insulation Resistance	20 M Ω or more (DC 25 V 1min)
4.Linearity	 ≤1.5%. Linearity(%)= ΔV/ (EV-SV) *100. ΔV: The difference between the ideal voltage and measured voltage on the each measuring line. SV: Voltage of starting Points. EV: Voltage of Ending Points.
5.Bouncing	<10ms (Tip R 3.75mm, hardness 10°~20° ,silicon rubber ,500gf operation : 40 mm/sec)

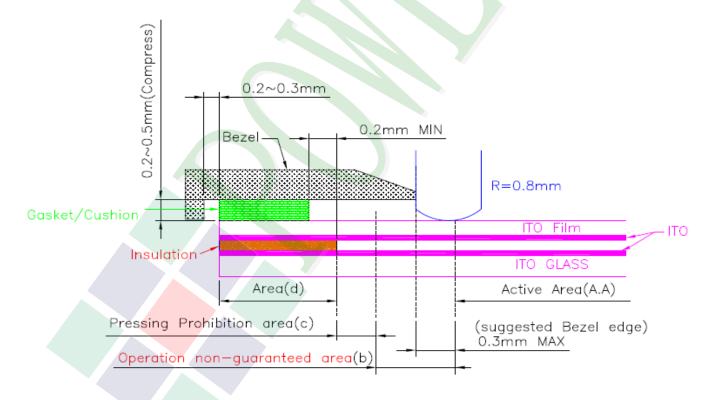


1.7.4 Reliability Characteristic

ltem	Specification				
1.Hitting Durability	1,000,000times min.(Tip R 8mm&R0.8mm)				
2.Pen Sliding Durability	100,000 times min(Tip R0.8mm).				
3.Impact Resistance	No damage when ψ 9mm steel ball is dropped on the surface from 30 cm height at 1 time.				
4.Flexible pattern Bending	Bending 3 times by bending radius R1.0 mm				
Resistance					
5.Flexible Pattern Insert/Pull					
Out Resistance	5times at least .				



- 1.7.5 Touch Panel Design/Handing Guide
- (1) Keep the gap, for example 0.2 to 0.3mm, between bezel edge and T/P edge. The reason is to avoid the bezel edge from contacting T/P surface that may cause "short" with bottom layer
- (2) Insertion a cushion material is recommended.
- (3) The cushion material should be limited on the busbar insulation paste area. If it is over the transparent insulation paste area, a "short" may be occurred.
- (4) Do not to use an adhesive tape to bond it on the front of T/P and hang it to the housing bezel.
- (5) Never expand the T/P top layer (PET Film) like a balloon by internal air pressure. The life of the T/P will extremely decreasing.
- (6) Top layer, PET, dimension is changing base on environment temperature and humidity. Please avoid a stress from housing bezel to top layer, because it may cause "waving".
- (7) The input to the Touch Panel sometimes distorts touch panel itself.
- (8)To use the stylus pen or fingernail sliding at the edge of the housing is prohibited. It would cause the cracking of the ITO coating and damage the touch panel. It also request not to press this area while assembling
- (9) Purpose: In order to prevent accidental use and performance deterioration, please keep the following precautions.



In order to prevent unusual performance degradation and malfunction of a touch panel, please carry out the set case designing and a touch panel assembling method after surely considering the definition of each area illustrated in above figure.



Area(a) : Active area

The active area is guaranteed the position data detectable precision, operation force and other operations. it is strongly recommended to place the operation button or menu keys within the active area. Due to structure, the active area is less durable at the edge or close to the edge.

Area(b) : Operation non-guaranteed area

This area does not guarantee a touch panel operation and its function. When this area is pressed, touch panel shows degradation of its performance and durability such as a pen sliding durability becomes about one-tenth compared with the active area (area-(a) as guaranteed area) and its operation force requires about double. About 0.5 mm outside from a boundary of the active area corresponds to this area.

Area(c) : Pressing prohibition area

The area which forbids pressing, because an excessive load is applied to a transparent electrode (ITO) and a serious damage is given to a touch panel function by pressing. About 0.5 mm outside from Operation non-guaranteed area .

Area(d) : Non-Active area The area does not activate even if pressed.

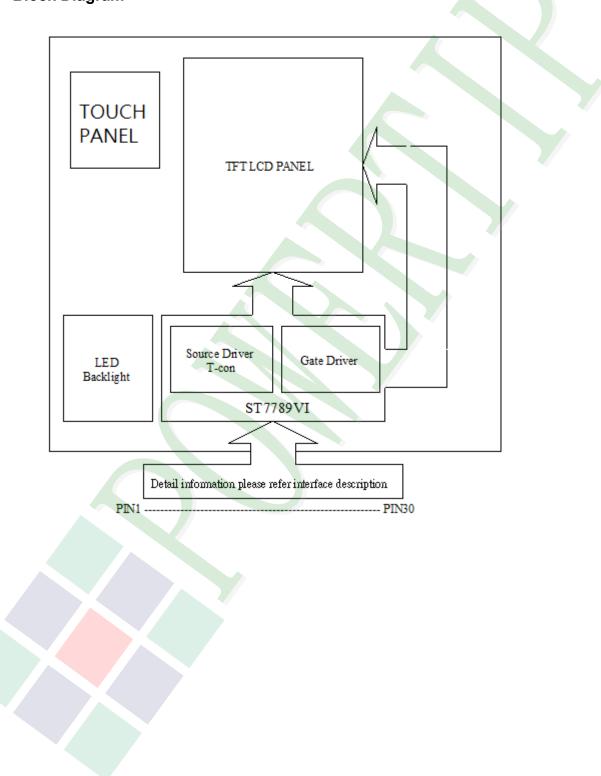


2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function					
1	LEDK1-4	Power supply for LED Backlight Cathode input					
2	LEDA	Power supply for LED Backlight Anode input					
3	GND	Signal ground.(0V)					
4	RESET	Reset input pin for TFT LCD. When RESET is "L", initialization is executed.					
5	DB17						
6	DB16						
7	DB15						
8	DB14						
9	DB13						
10	DB12						
11	DB11						
12	DB10	i-directional data bus					
13	DB8						
14	DB7						
15	DB6						
16	DB5						
17	DB4						
18	DB3						
19	DB2						
20	DB1						
21	RD	Read signal input - active at Low.					
22	WR/SCL	Write signal input , active at Low.					
23	RS	When RS = 0: Command. When RS = 1: Display data.					
24	CS	Chip select signal , Active at "L"					
25	XR	Right side of touch panel.					



Pin No.	Symbol	Function
26	YD	Bottom side of touch panel.
27	XL	Left side of touch panel.
28	YU	Up side of touch panel.
29	GND	Signal ground.(0V)
30	2.8 /VCC	Power supply for the internal logic circuit.



2.2.1 Reference Initial code void LCD_Init(void) {

LCD_WR_REG(0x01);

delay_ms(100);

LCD_WR_REG(0x11);

delay_ms(120);

LCD_WR_REG(0x36); LCD_WR_DATA(0x00);

LCD_WR_REG(0x3a); LCD_WR_DATA(0x55);

LCD_WR_REG(0xb2); LCD_WR_DATA(0x0C); LCD_WR_DATA(0x0C); LCD_WR_DATA(0x00); LCD_WR_DATA(0x33); LCD_WR_DATA(0x33);

LCD_WR_REG(0xb7); LCD_WR_DATA(0x35);

LCD_WR_REG(0xbb); LCD_WR_DATA(0x19);

LCD_WR_REG(0xc0); LCD_WR_DATA(0x2c);

LCD_WR_REG(0xc2); LCD_WR_DATA(0x01);

LCD_WR_REG(0xc3); LCD_WR_DATA(0x12);



LCD_WR_REG(0xc4); LCD_WR_DATA(0x20);

LCD_WR_REG(0xc6); LCD_WR_DATA(0x0f);

LCD_WR_REG(0xd0); LCD_WR_DATA(0xa4); LCD_WR_DATA(0xa1);

/*-----Gamma Set-----*/ LCD WR REG(0xe0); LCD WR DATA(0xd0); LCD_WR_DATA(0x04); LCD_WR_DATA(0x0d); LCD WR DATA(0x11); LCD WR DATA(0x13); LCD WR DATA(0x2b); LCD WR DATA(0x3f); LCD WR DATA(0x54); LCD WR DATA(0x4c); LCD WR DATA(0x18); LCD_WR_DATA(0x0d); LCD WR DATA(0x0b); LCD WR DATA(0x1f); LCD WR DATA(0x23);

> LCD_WR_REG(0xe1); LCD_WR_DATA(0xd0); LCD_WR_DATA(0x04); LCD_WR_DATA(0x0c); LCD_WR_DATA(0x11); LCD_WR_DATA(0x13); LCD_WR_DATA(0x2c); LCD_WR_DATA(0x3f); LCD_WR_DATA(0x44); LCD_WR_DATA(0x51); LCD_WR_DATA(0x2f); LCD_WR_DATA(0x1f);



}

LCD_WR_DATA(0x1f); LCD_WR_DATA(0x20); LCD_WR_DATA(0x23); /*-----Gamma Set End------*/

LCD_WR_REG(0x29); //Display on



2.3 Timing Characteristics

8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus

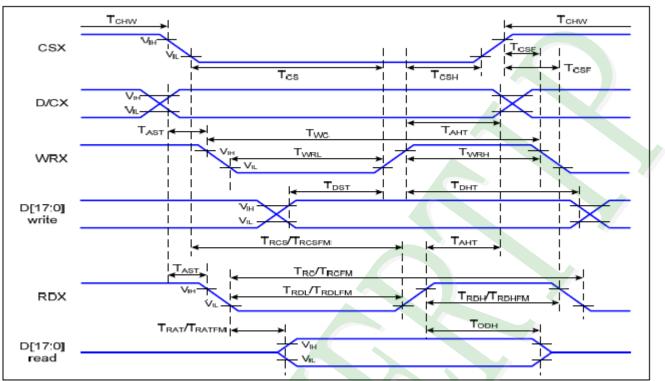


Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)



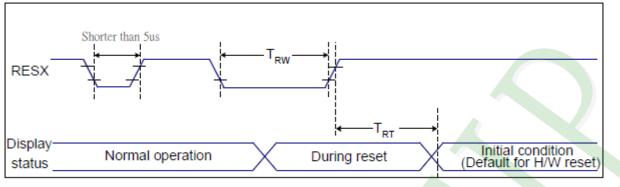
Parameter Signal Symbol Min Max Unit Description 0 TAST Address setup time ns D/CX TAHT Address hold time (Write/Read) 10 ns Chip select "H" pulse width 0 T_{CHW} ns Chip select setup time (Write) 15 Tcs ns Chip select setup time (Read ID) 45 TRCS ns CSX Chip select setup time (Read FM) 355 T_{RCSFM} ns T_{CSF} Chip select wait time (Write/Read) 10 ns Chip select hold time TCSH 10 ns Write cycle 66 Twc ns Control pulse "H" duration WRX TWRH 15 ns TWRL Control pulse "L" duration 15 ns Read cycle (ID) 160 TRC ns RDX (ID) TRDH Control pulse "H" duration (ID) 90 When read ID data ns Control pulse "L" duration (ID) 45 TRDL ns Read cycle (FM) TRCFM 450 ns RDX When read from TRDHEM Control pulse "H" duration (FM) 90 ns (FM) frame memory Control pulse "L" duration (FM) 355 TRDLFM ns D[17:0] TDST Data setup time 10 For CL=30pF ns 10 TDHT Data hold time ns TRAT Read access time (ID) 40 ns Read access time (FM) 340 TRATEM ns Output disable time TODH 20 80 ns

VDDI=1.65 to 3.6V, VDD=2.4 to 3.6V, AGND=DGND=0V, Ta= 25 C

8080 Parallel Interface Characteristics



Reset Timing:



Reset Timing

VDDI=1.65 to 3.6V, VDD=2.4 to 3.6V, AGND=DGND=0V, Ta=25 C

Related Pins	Symbol	Parameter	MIN	МАХ	Unit
TRW		Reset pulse duration	10	-	us
RESX	TOT	RT Reset cancel	-	5 (Note 1, 5)	ms
	IKI			120 (Note 1, 6, 7)	ms

Reset Timing

Notes:

 The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

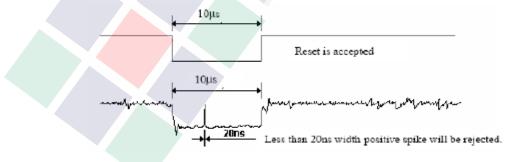
RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120

ms, when Reset Starts in Sleep Out -mode. The display remains the blank state in Sleep In -mode.) and then return to Default condition

for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.

6. When Reset applied during Sleep Out Mode.

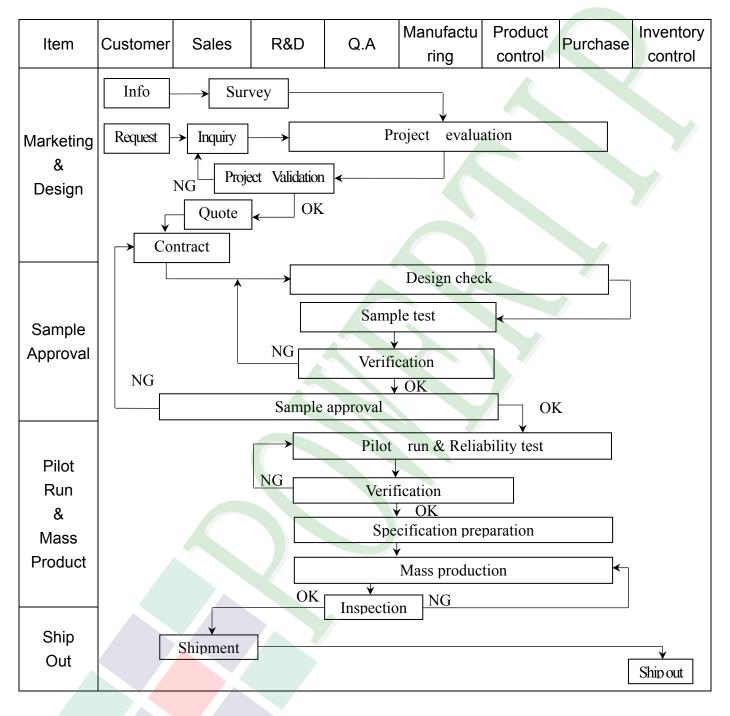
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for

120msec.



3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



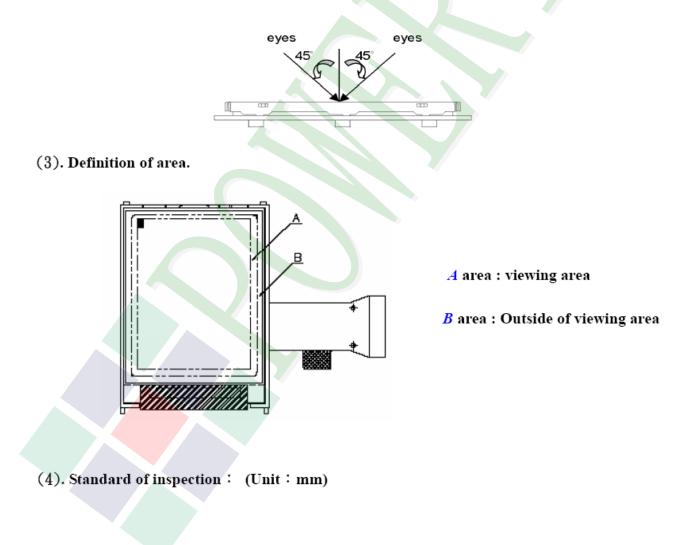


Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info	Claim sis report	[Trackin	Failure an Corrective			
Q.A Activity	1. ISO 900 3. Equipme 5. Standard	ent calibrati	ion	4	Process in Education			es

POWERTIP

3.2 Inspection Specification

- \clubsuit Scope : The document shall be applied to TFT-LCD Module for less than 3.5" (Ver.B01).
- ◆Inspection Standard:MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
- ◆Defect Level : Major Defect AQL : 0,4 ; Minor Defect AQL : 1,5
- ♦OUT Going Defect Level : Sampling.
- ◆Standard of the product appearance test:
 - a. Manner of appearance test :
 - (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line.





◆Specification For TFT-LCD Module Less Than 3.5″:

◆Specification For TFT-LCD Module Less Than 3.5″:					(Ver.B01)	
Item		Criterion				
		1. 1The part number is inconsistent with work order of production.				
01 Product condition	1. 2 Mixed	prod	luct types.		Major	
	1. 3 Assem	bled	in inverse direction.		Major	
Quantity	2. 1The qu	antit	y is inconsistent with	n work order of production.	Major	
Outline dimension		3. 1 Product dimension and structure must conform to structure diagram.				
04 Electrical Testing	4. 1 Missin	ıg lin	e character and icon	·	Major	
	4. 2 No function or no display.					
	4. 3 Display malfunction.					
	4.4 LCD viewing angle defect.				Major	
	4. 5 Current consumption exceeds product specifications.					
			Item	Acceptance (Q'ty)		
Dot defect			Bright Dot	≤ 2		
	D	Dot	Dark Dot	≤ 3		
(Bright dot \	De	fect	Joint Dot	≤ 2		
Dark dot)			Total	≤ 3	Minor	
On display	5. 1 Inspection pattern : full white , full black , Red , Green and				L	
On -dísplay	blue screens.					
	5. 2 It is defined as dot defect if defect area $>1/2$ dot.					
5. 3 The distance between two dot defect ≥ 5 mm.						
	Item Product condition Quantity Outline dimension Electrical Testing Dot defect (Bright dot \	Item1. 1The pa product productProduct condition1. 2 Mixed1. 2 Mixed1. 3 AssemQuantity2. 1The quadiagraOutline dimension3. 1 ProduadiagraQuantity4. 1 Missin4. 2 No fur4. 2 No fur4. 3 Displa4. 4 LCD4. 4 LCD4. 5 CurreUbbrief dot \ Dark dot)5. 1 InspectorOn -display5. 2 It is dot	ItemI. 1The part numproductionProduct condition1. 1The part numproduction1. 2 Mixed prod1. 3 AssembledQuantity2. 1The quantitOutline dimension3. 1 Product dim diagram.A. 1 Missing line4. 2 No functionElectrical Testing4. 3 Display mail4. 4 LCD viewi4. 5 Current conditionDot defectDot Defect(Bright dot ` Dark dot)5. 1 InspectionOn -display5. 2 It is defined	ItemCriteriaProduct condition1. 1The part number is inconsistent production.Product condition1. 2 Mixed product types.1. 3 Assembled in inverse direction.Quantity2. 1The quantity is inconsistent with 3. 1 Product dimension and structur diagram.Outline dimension3. 1 Product dimension and structur diagram.Electrical Testing4. 1 Missing line character and icon 4. 2 No function or no display.Electrical Testing4. 3 Display malfunction.4. 4 LCD viewing angle defect.4. 5 Current consumption exceeds product Dark Dot DefectDot defectJoint Dot Total(Bright dot ` Dark dot)On -display5. 1 Inspection pattern : full white blue screen 5. 2 It is defined as dot defect if defect	Item Criterion Product condition 1. 1The part number is inconsistent with work order of production. Product condition 1. 2 Mixed product types. 1. 3 Assembled in inverse direction. 2. 1The quantity is inconsistent with work order of production. Quantity 2. 1The quantity is inconsistent with work order of production. Outline dimension 3. 1 Product dimension and structure must conform to structure diagram. 4. 1 Missing line character and icon. 4. 2 No function or no display. 4. 3 Display malfunction. 4. 3 Display malfunction. 4. 4 LCD viewing angle defect. 4. 5 Current consumption exceeds product specifications. Dot defect Dot Dark Dot ≤ 2 Dot Defect Joint Dot ≤ 2 Dot defect Joint Dot ≤ 3 5. 1 Inspection pattern : full white , full black , Red , Green and blue screens. 5. 2 It is defined as dot defect if defect area >1/2 dot. 5. 1 tis defined as dot defect if defect area >1/2 dot.	



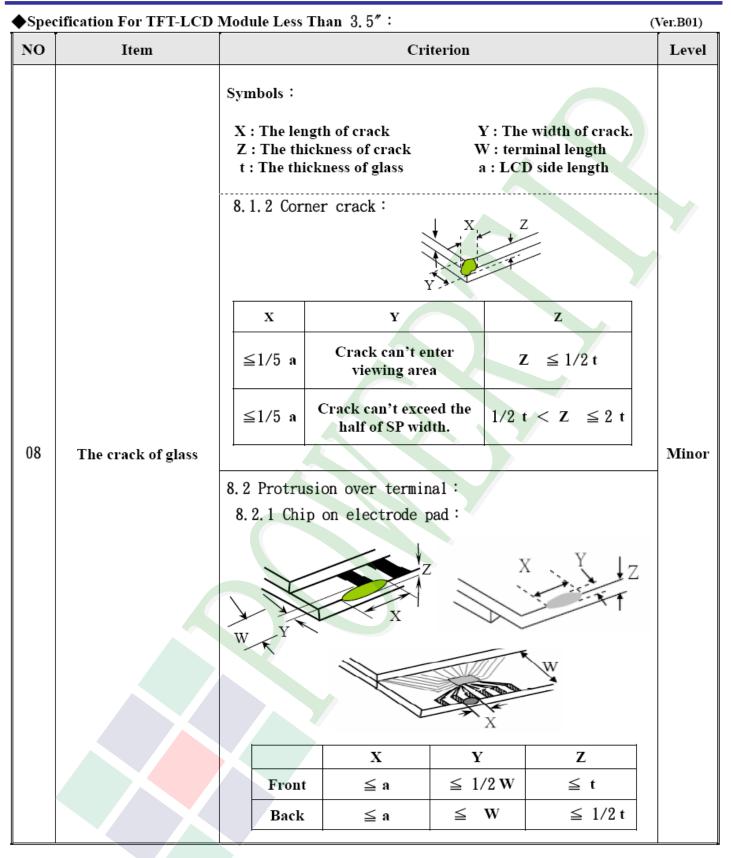
Specification For TFT-LCD Module Less Than 3.5″:								
NO	Item	Crite	Criterion					
		6. 1 Round type (Non-display or	r display) 🕻					
		Dimension (diameter : Ф)	Acceptance	(Q'ty) B area				
	Black or white dot \ scratch \	$\Phi \leq 0.15$	A area Ignore	b area				
	contamination	$0.15 \ < \ \Phi \leq 0.20$	2					
	Round type	$0.20 \ < \ \Phi \leq 0.30$	2	Ignore				
	→ x ←	$\Phi > 0.30$	0					
06	Y Y	Total	3		Minor			
	$\Phi = (x+y) / 2$	6. 2 Line type(Non-display or di	isplay) :					
	Line type	Dimension	Acceptan	ce (Q'ty)				
	⊥ine type ↓	Length (L) Width (W)	A area	B area				
	↓ ↓ W	$$ W ≤ 0.0	03 Ignore					
		$L \le 5.0$ 0.03 < W ≤ 0.0	5 3	T				
		W >0.0	05 As round type	Ignore				
		Total	3					
		Dimension	Acceptance (Q'ty)				
		(diameter ÷ Φ)	A area	B area				
	Polarizer	$\Phi \leq 0.20$	Ignore					
07	Bubble	$0.20 < \Phi \leq 0.50$	3	Ignore	Minor			
		$\Phi > 0.50$	0	ignore				
		Total	3					
				y				



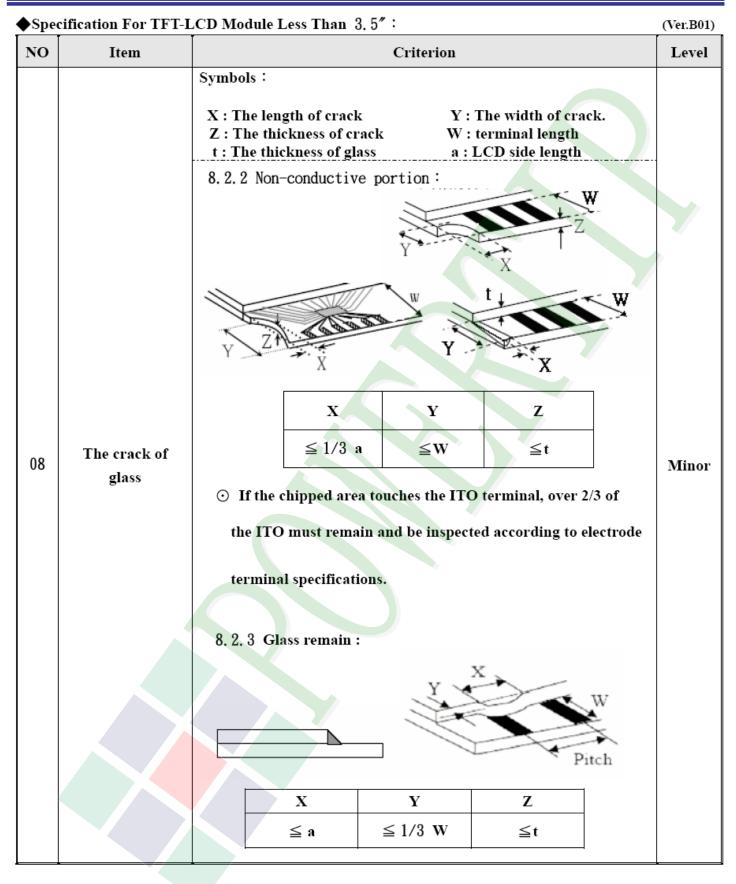
\clubsuit Specification For TFT-LCD Module Less Than 3. 5" :

Spec	ification For TFT-LCD N	Module Less Than 3.5" :		(Ver.B01)		
NO	Item	Criterion				
		Z : The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length			
		8.1 General glass chip: 8.1.1 Chip on panel surface and cra	ack between panels:			
		Y Y Z Z	Y			
08	The crack of glass		SP [NG]	Minor		
		Seal width	Y			
		XY	Z			
		≤ a Crack can't enter viewing area	$\leq 1/2 t$			
		≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$			











◆Specification For TFT-LCD Module Less Than 3.5″:

♦ Spec	Specification For TFT-LCD Module Less Than 3, 5" :				
NO	Item	Criterion	Level		
	Backlight elements	9. 1 Backlight can't work normally.	Major		
09		9. 2 Backlight doesn't light or color is wrong.	Major		
		9. 3 Illumination source flickers when lit.	Major		
	General appearance	10. 1 Pin type \ quantity \ dimension must match type in structure diagram.	Major		
		10. 2 No short circuits in components on PCB or FPC .	Major		
10		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major		
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor		
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor		
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor		



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

TEST ITEMgh Temperature Storage Testow Temperature Storage Testgh Temperature / High Humidity Storage Testnperature Cycling Storage Test	Keep in +80 ±2°C 240hrs Surrounding temperature, then s Keep in -30 ±2°C 240hrs Surrounding temperature, then s Keep in +60 °C / 90% R.H durat Surrounding temperature, then s (Excluding the polarizer) $-30°C \rightarrow +25°C$ (30mins) (5mins) 20 Surrounding temperature, then s Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	torage at normal condition 4hrs. ion for 240hrs torage at normal condition 4hrs. $\rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) Cycle torage at normal condition 4hrs. Contact Discharge: Apply 250 V with 5 times	
Storage Test Storage Test Storage Test gh Temperature / High Humidity Storage Test perature Cycling Storage Test	Surrounding temperature, then s Keep in -30 $\pm 2^{\circ}$ C 240hrs Surrounding temperature, then s Keep in +60 °C / 90% R.H durat Surrounding temperature, then s (Excluding the polarizer) -30°C \rightarrow +25°C (30mins) (5mins) 20 Surrounding temperature, then s Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	torage at normal condition 4hrs. ion for 240hrs torage at normal condition 4hrs. $\rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) Cycle torage at normal condition 4hrs. Contact Discharge: Apply 250 V with 5 times	
Storage Test gh Temperature / High Humidity Storage Test perature Cycling Storage Test	Surrounding temperature, then so Keep in +60 °C / 90% R.H durat Surrounding temperature, then so (Excluding the polarizer) $-30^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) 20 Surrounding temperature, then so Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	ion for 240hrs torage at normal condition 4hrs. $\rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) Cycle torage at normal condition 4hrs. Contact Discharge: Apply 250 V with 5 times	
High Humidity Storage Test operature Cycling Storage Test	Surrounding temperature, then si (Excluding the polarizer) -30°C → +25°C (30mins) (5mins) 20 Surrounding temperature, then si Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	torage at normal condition 4hrs. $\rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) Cycle torage at normal condition 4hrs. Contact Discharge: Apply 250 V with 5 times	
Storage Test	(30mins) (5mins) 20 Surrounding temperature, then so Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	(30mins) (5mins) Cycle torage at normal condition 4hrs. Contact Discharge: Apply 250 V with 5 times	
	Surrounding temperature, then so Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	torage at normal condition 4hrs. Contact Discharge: Apply 250 V with 5 times	
	Apply 2 KV with 5 times Discharge for each polarity +/-	Apply 250 V with 5 times	
ESD Test		‰ Cs+Cd):150pF±10% 0Ω±10%	
Vibration Test (Packaged)	 (Tolerance if the output voltage indication : ±5%) 1. Sine wave 10~55 Hz frequency (1 min/sweep) 2. The amplitude of vibration :1.5 mm 3. Each direction (X \ Y \ Z) duration for 2 Hrs 		
Drop Test (Packaged)	Packing Weight (Kg 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454	g) Drop Height (cm) 122 76 61 46	
	(Packaged) Drop Test	Output voltage in (Tolerance if the output voltage in (Tolerance if the output voltage in 1. Sine wave 10~55 Hz frequen 2. The amplitude of vibration :1. 3. Each direction (X \ Y \ Z) du Packing Weight (Kg 0 \ 45.4 \ 45.4 \ 90.8 \ 90.8 \ 454	

POWERTIP

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°Cand 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .
- 5.2.10 Caution!(LCM products with Capacitive Touch Panel) Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested inside the target application.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}C \pm 5^{\circ}C$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

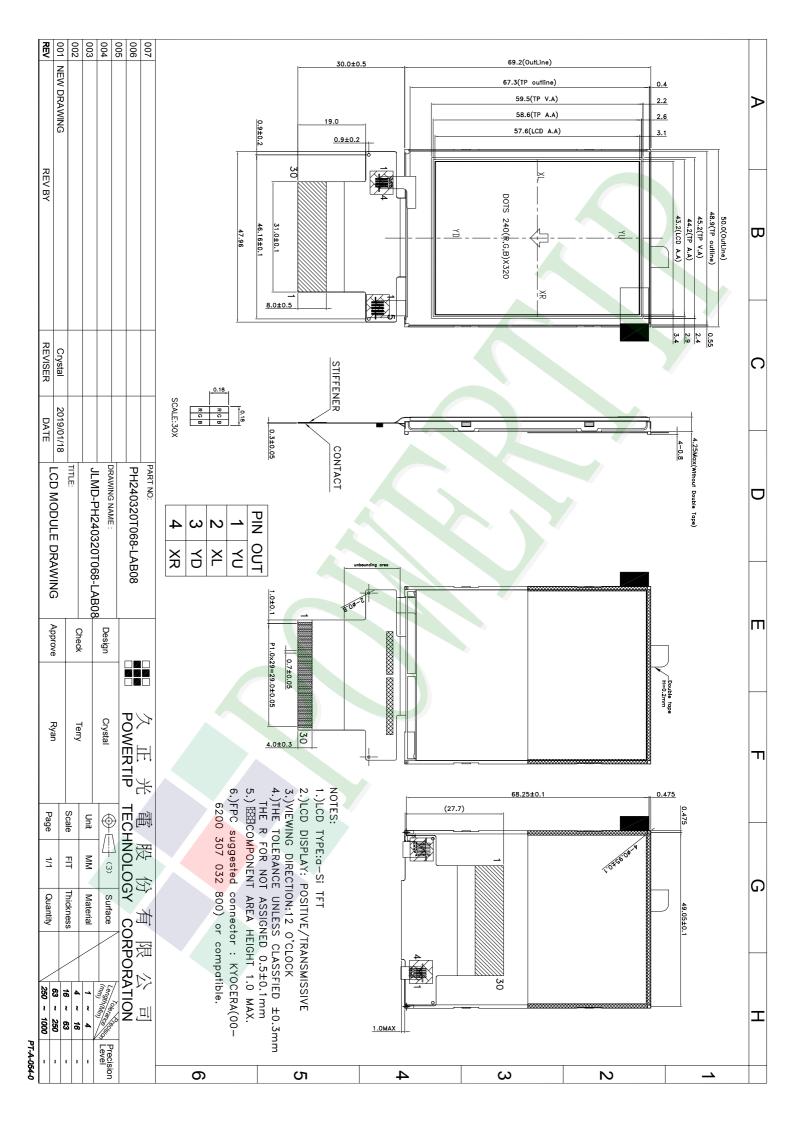
5.4 TERMS OF WARRANTY

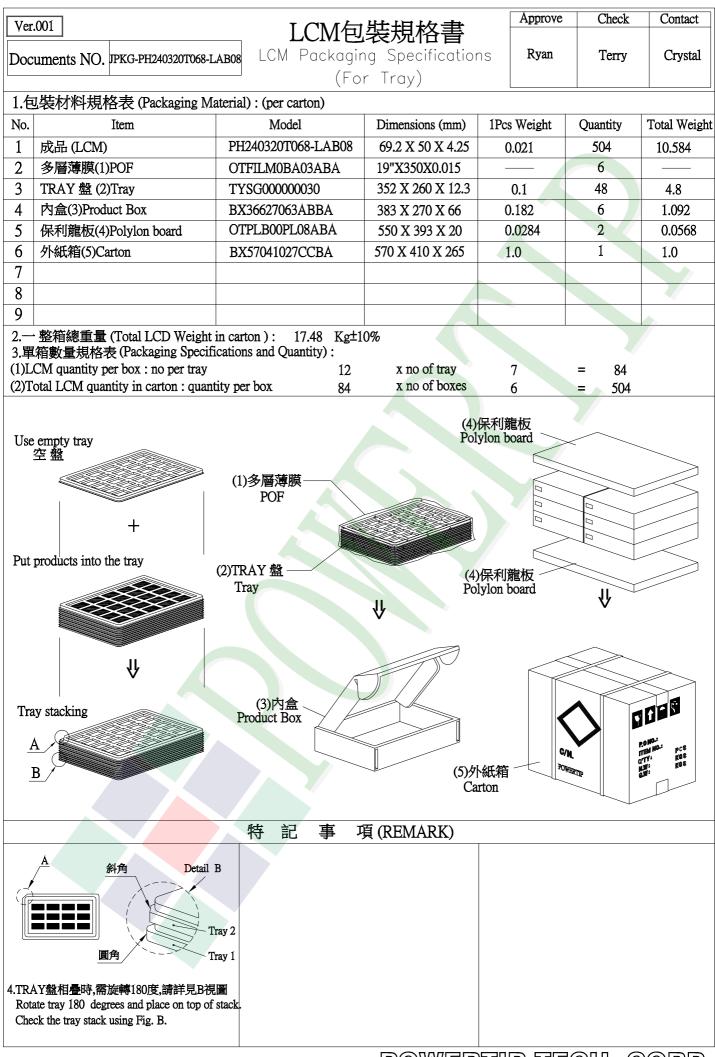
- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in



nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.





POWERTIP TECH. CORP.